

# CRMKTL10150A

N-Channel 100V, 120mΩ Typ. Power MOSFET

## Description

### **Features**

• 100V, 10A

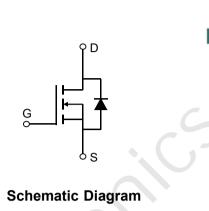
 $R_{DS(ON)}$  Typ = 120m $\Omega$  @ V<sub>GS</sub> = 10V

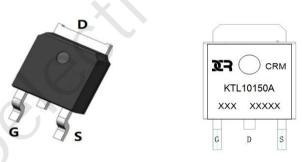
 $R_{DS(ON)}$  Typ = 126m $\Omega$  @ V<sub>GS</sub> = 4.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

## Application

- Load Switch
- PWM Application
- Power Management





#### Marking and Pin Assignment

#### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL10150A	CRMKTL10150A	TO-252-3L	TAPING	13"	2500	25000

#### Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V <sub>DS</sub>	Drain-to-Source Voltage		100	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	10	А
Ι <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> = 100°C	6	А
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		40	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>(2)</sup>		12	mJ
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C	26.6	W
$R_{ ext{ hetaJC}}$	Thermal Resistance, Junction to Case		4.7	°C/W
T <sub>J</sub> , T <sub>stg</sub>	Junction & Storage Temperature Range		-55 to 150	°C



#### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1.0	μΑ
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	1	2	2.5	V
_	(3)	V <sub>GS</sub> = 10V, I <sub>D</sub> = 5A	-	120	156	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3A	-	126	164	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		-	655	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz	Χ-	31	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1101112		24	-	pF
Q <sub>g</sub>	Total Gate Charge	0	<u> </u>	14.8	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 50V$ , $I_D = 3A$	) -	3	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$ , $i_{\rm D} = 3A$	-	4.4	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	12	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 50V	-	7.6	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D$ = 3A, $R_{GEN}$ = 3 $\Omega$	-	36	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	9.2	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source D	iode Forward Current	-	-	10	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	40	А
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A	-	-	1.2	V
Notes:	1. Repetitive Rating: Pulse Width Limited by Maxin	num Junction Temperature.				

2.  $E_{AS}$  condition: Starting T<sub>J</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, R<sub>G</sub>=250hm, L=0.5mH, I<sub>AS</sub>=7A

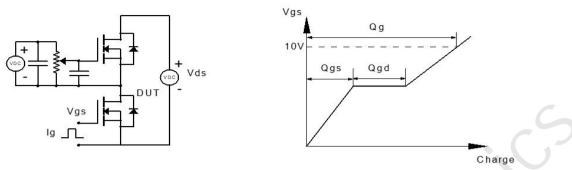
3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

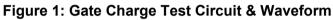


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## **Test Circuit**





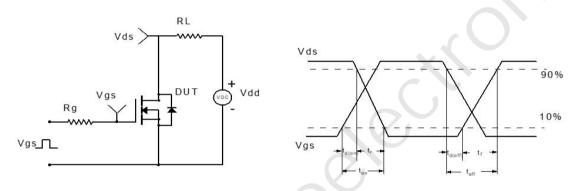
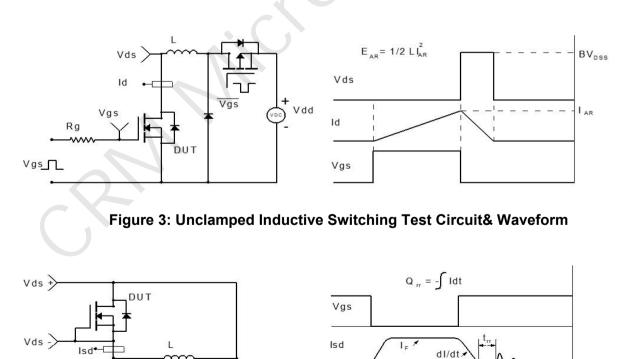


Figure 2: Resistive Switching Test Circuit & Waveform





↓+ voc Vdd

Ig

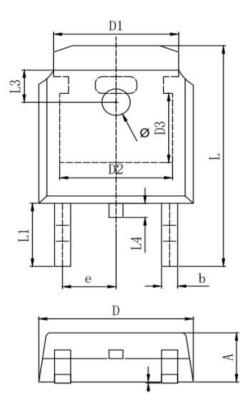
Vdd

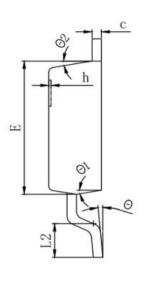
I\_BA

Vds



## Package Mechanical Data(TO-252-3L)





SYMBOL	MILLIMETER				
SIMBOL	MIN	Typ.	MAX		
A	2.200	2.300	2.400		
Al	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6.700		
D1	5.334 REF				
D2	4.826 REF				
D3	3.166 REF				
E	6.000	6.100	6.200		
е	2. 286 TYP				
h	0.000	0.100	0.200		
L	9.900	10.100	10.300		
L1	2.888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
ф	1.100	1.200	1.300		
θ	0°		8°		
θ1	9° TYP				
02	9° TYP				

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## **Contact information**

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